

Vishay Siliconix

N-Channel 40-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS} (V)	V _{(BR)DSS} (V) r _{DS(on)} (Ω)				
40	0.0074 at V _{GS} = 10 V	70 ^a			
	0.011 at V _{GS} = 4.5 V	67			

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- Low Threshold



APPLICATIONS

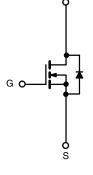
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Motor Control



TO-263

G D S Top View



Ordering Information: SUM70N04-07L-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless oth	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	40	v	
Gate-Source Voltage	V _{GS}	± 20	v	
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	1	70 ^a	A
Continuous Drain Current $(T_j = 175 C)$	T _C = 125 °C		47	
Pulsed Drain Current	I _{DM}	120		
Avalanche Current	I _{AR}	40		
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	80	mJ
	T _C = 25 °C	Р	100 ^c	14/
Maximum Power Dissipation ^b	T _A = 25 °C ^d	– P _D –	3.75	W
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount ^d	R _{thJA}	40	°C/W		
Junction-to-Case		R _{thJC}	1.4	C/W		

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply.

SUM70N04-07L

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V$, $I_{D} = 250 \mu A$	40			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			100	nA	
		$V_{DS} = 32 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	0 μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 32 V, V_{GS} = 0 V, T_{J} = 125 °C			50		
		V_{DS} = 32 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	100			Α	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.006	0.0074		
		V _{GS} = 4.5 V, I _D = 10 A		0.0085	0.011		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 125 °C			0.012	Ω	
		V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 175 °C			0.015		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	20			S	
Dynamic ^b	44			4	ι ι		
Input Capacitance	C _{iss}			2800		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		320			
Reverse Transfer Capacitance	C _{rss}			190			
Total Gate Charge ^c	Qg			50	75	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		10			
Gate-Drain Charge ^c	Q _{gd}			10			
Gate Resistance	R _G			2.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			11	20		
Rise Time ^c	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 0.4 \Omega$		20	30	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{G}} = 2.5 \Omega$		40	60		
Fall Time ^c	t _f			15	25		
Source-Drain Diode Ratings and Cha	aracteristics T	C _C = 25 °C ^b			1		
Continuous Current	۱ _S				66		
Pulsed Current	I _{SM}				100	A	
Forward Voltage ^a	V _{SD}	I _F = 50 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			30	50	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		1.6	2.4	А	
Reverse Recovery Charge	Q _{rr}			0.024	0.06	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



SUM70N04-07L

T_C = 125 °C

2.5

 $V_{GS} = 10 V$

60

I_D - Drain Current (A)

80

100

40

20

Gate Charge

30

3.0 3.5 4.0

25 °

2.0

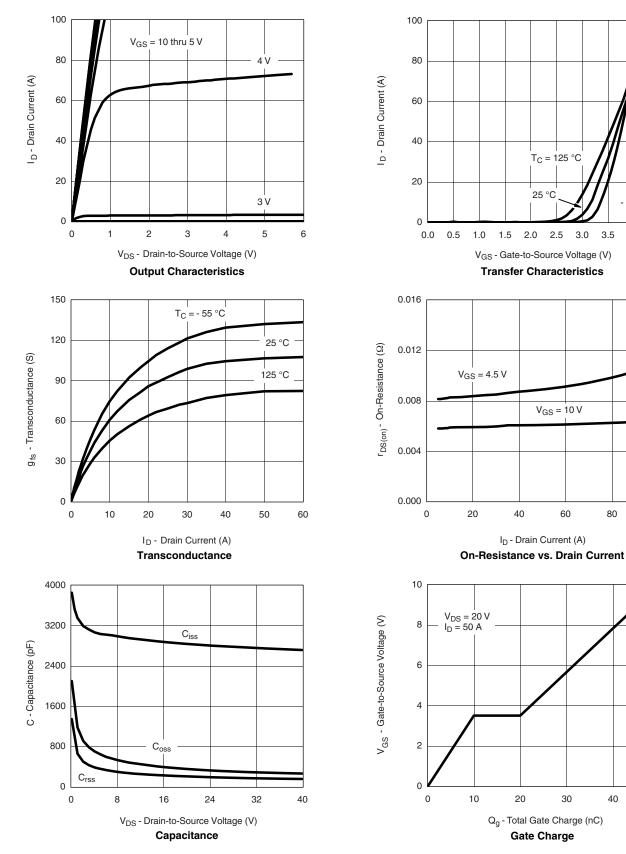
1.5

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- 55 °C

4.5

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

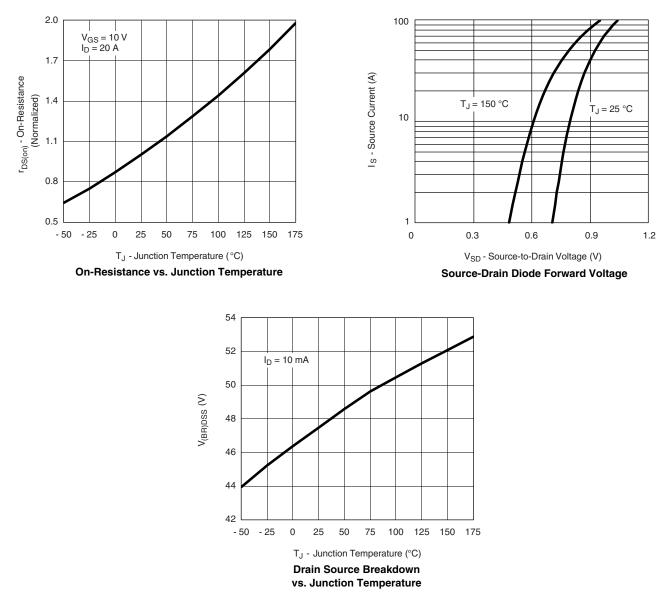


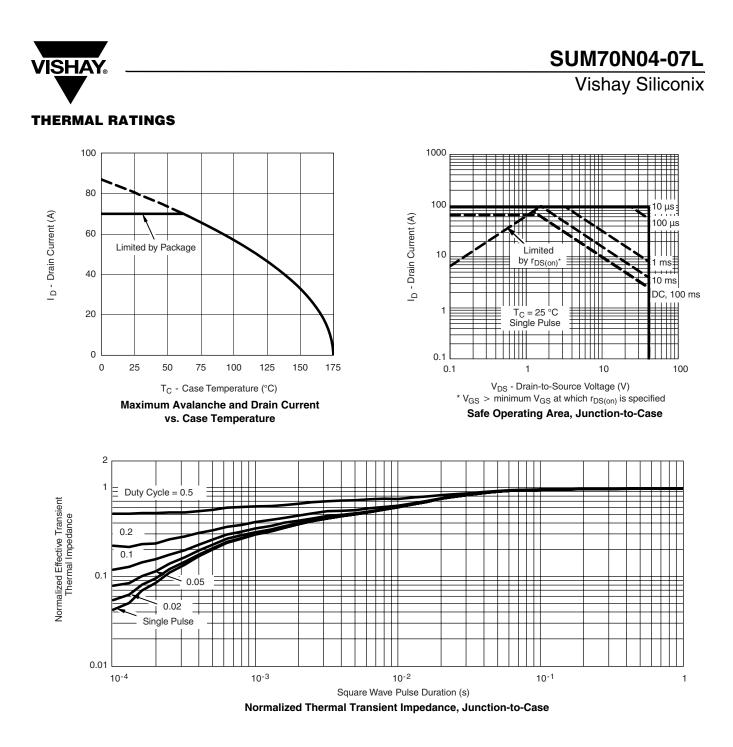
Document Number: 72345 S-80274-Rev. B, 11-Feb-08 50

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





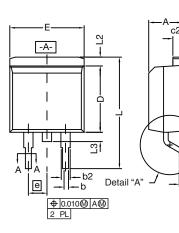
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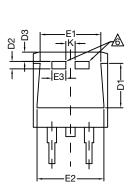


Package Information

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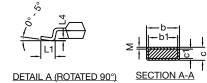
TO-263 (D²PAK): 3-LEAD





-B-

С



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
А		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
E		0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	0.100 BSC		BSC	
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
М		-	0.002	-	0.050	
ECN: T10-0738-Rev. J, 03-Jan-11 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
- Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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